

/ Descriptions

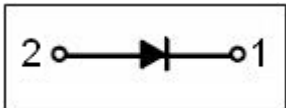
/ Features

Low positive pressure drop, HF Product.

/ Applications

Schottky diode.

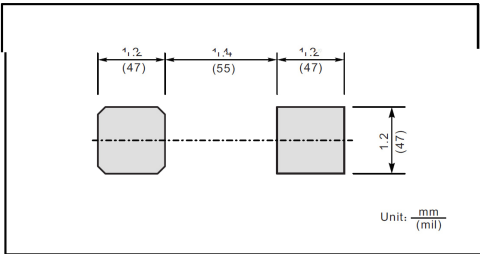
/ Equivalent Circuit



/ Pinning



The recommended mounting pad size



/ h_{FE} Classifications & Marking

/ Absolute Maximum Ratings(Ta=25)

	θ		

/ Electrical Characteristics(Ta=25)

/ Electrical Characteristic Curve

Fig.1 Power Derating Curve

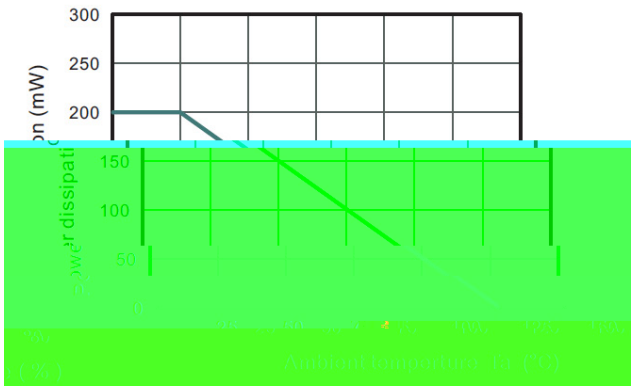


Fig.2 Typical Reverse Characteristics

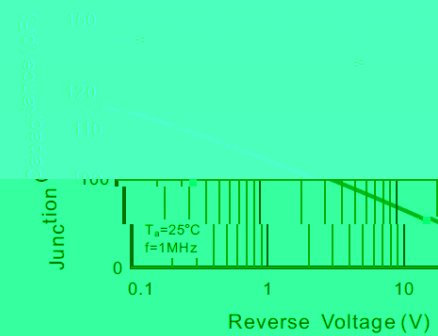
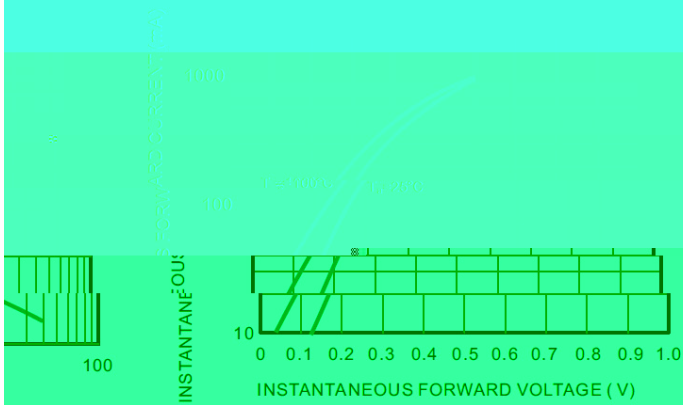
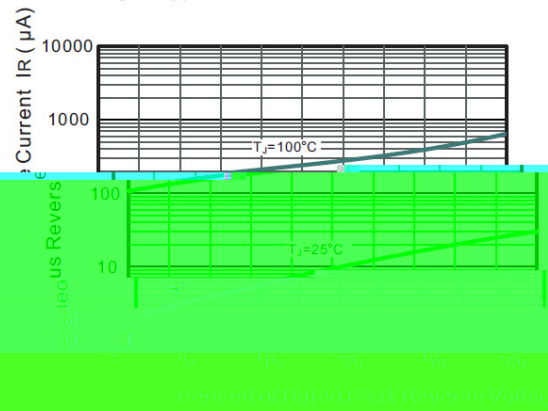
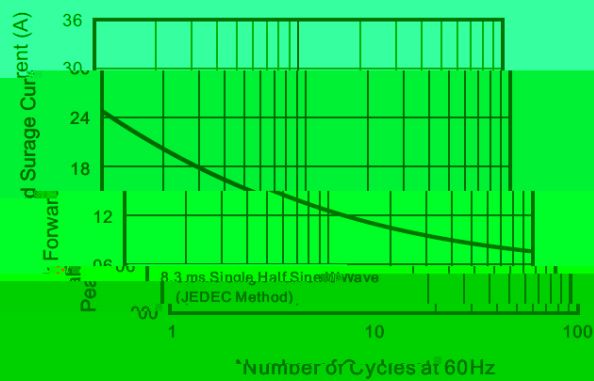
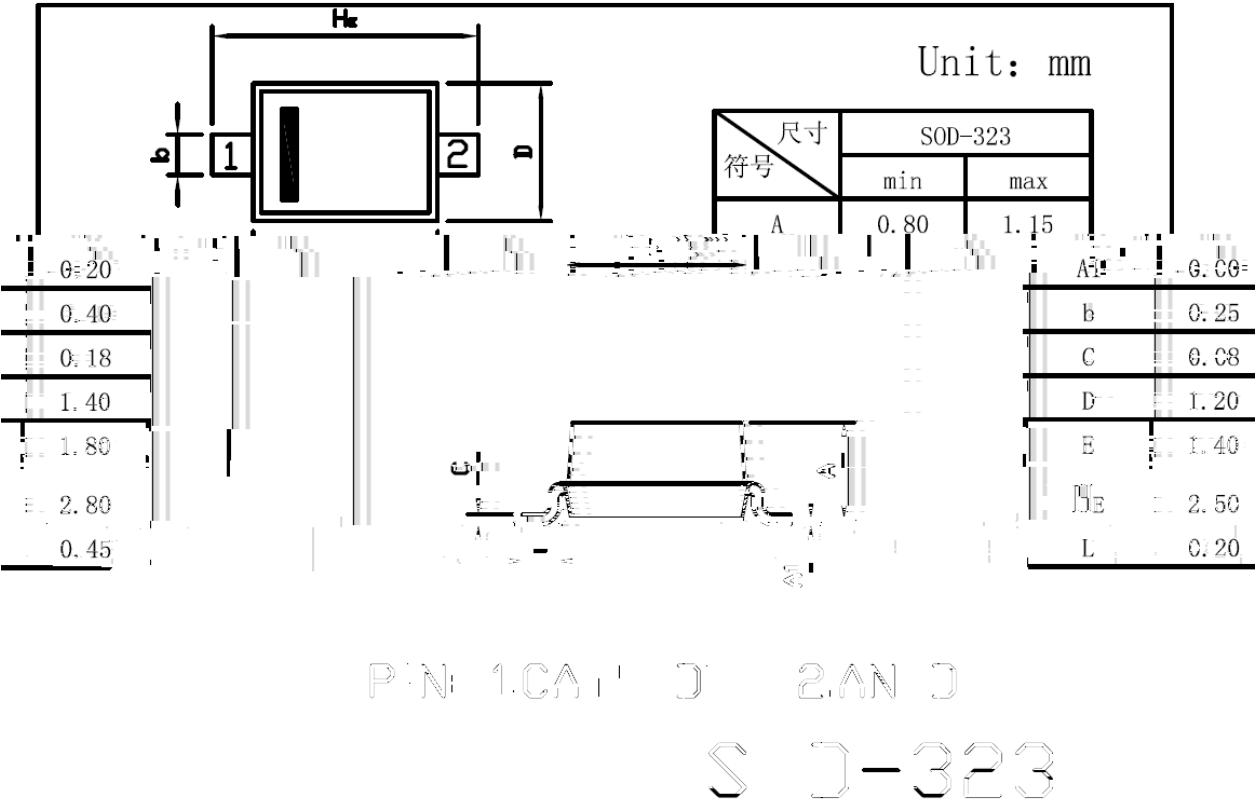


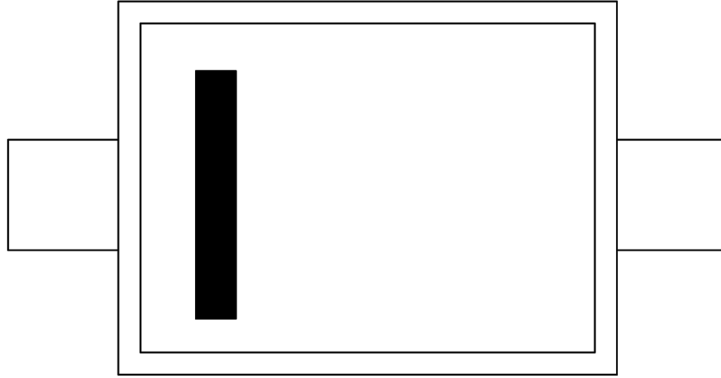
Fig.5 Maximum Non-Repetitive Peak Forward Surge Current



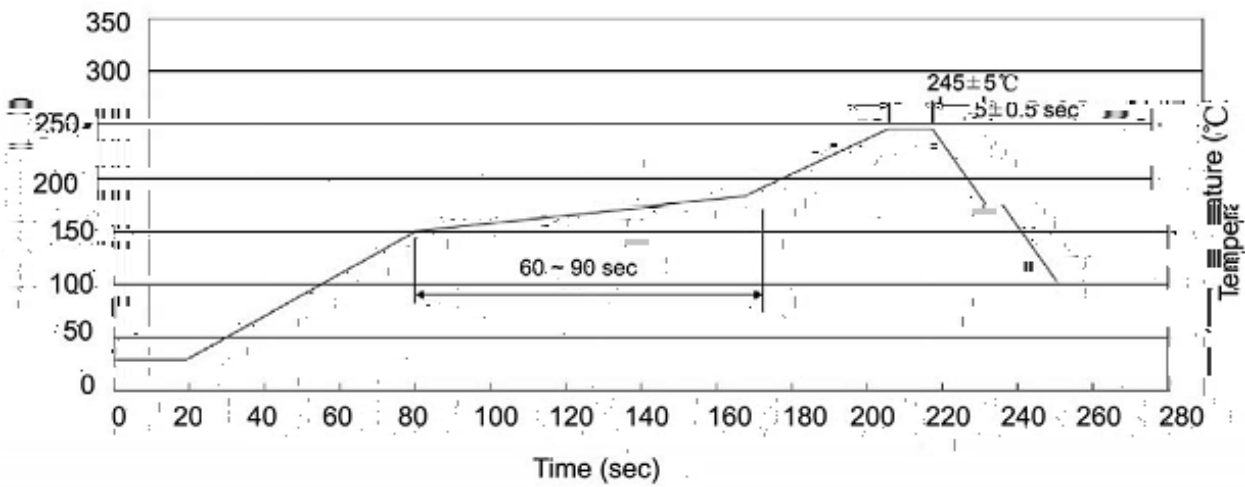
/ Package Dimensions



/ Marking Instructions



() / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ± ± ±

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	只 卷盘	卷盘 盒	只 盒	盒 箱	只 箱		盒	箱